



Trace and Space Capabilities 2015

Starting Copper Weight	Standard Processing		Advanced Processing			
	Etched Layers <i>Print & Etch</i>	Plated Layers <i>1 Mil Extra Cu Plating</i>	<i>No Blind, Burried or Via in Pad</i>		<i>With Blind, Burried or Via InPad</i>	
			Etched Layers <i>Print & Etch</i>	Plated Layers <i>1 Mil Extra Cu Plating</i>	Class 2 <i>Wrap Cu Plating</i>	Class 3 <i>Wrap Cu Plating</i>
1/4 Ounce (.00035)	N/A	.0035/.0035	.0024/.0024	.0028/.0028	.0035/.0035	.0039/.0039
1/2 Ounce (.0007)	.004/.004	.0050/.0050	.0030/.0030	.0035/.0035	.0041/.0041	.0045/.0045
1 Ounce (.0014)	.005/.005	.0065/.0065	.0040/.0040	.0046/.0046	.0054/.0054	.0058/.0058
2 Ounce (.0028)	.008/.008	.0100/.0100	.0060/.0060	.0070/.0070	.0079/.0079	.0083/.0083